

SEMICONDUCTOR®

# N-Channel Power Trench<sup>®</sup> MOSFET 30 V, 19.5 A, 5.3 m $\Omega$

# Features

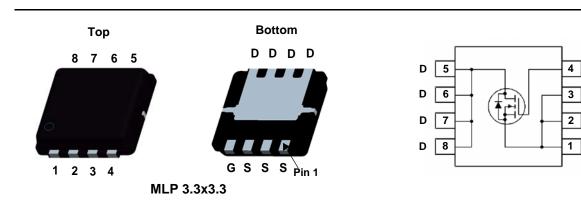
- Max  $r_{DS(on)}$  = 5.3 m $\Omega$  at V<sub>GS</sub> = 10 V, I<sub>D</sub> = 17.5 A
- Max  $r_{DS(on)} = 6.8 \text{ m}\Omega$  at  $V_{GS} = 4.5 \text{ V}$ ,  $I_D = 15.0 \text{ A}$
- High performance technology for extremely low r<sub>DS(on)</sub>
- Termination is Lead-free and RoHS Compliant

# **General Description**

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced Power Trench<sup>®</sup> process that has been especially tailored to minimize the on-state resistance. This device is well suited for Power Management and load switching applications common in Notebook Computers and Portable Battery Packs.

# Application

- DC DC Buck Converters
- Notebook battery power management
- Load switch in Notebook



# MOSFET Maximum Ratings T<sub>A</sub> = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units				
V <sub>DS</sub>	Drain to Source	e Voltage				30	V		
V <sub>GS</sub>	Gate to Source	Voltage			(Note 3)	±20	V		
ID	Drain Current	Drain Current -Continuous (Package limited) T <sub>C</sub> = 25 °C				19.5			
	Drain Current	-Continuous (Silic	on limited)	T <sub>C</sub> = 25 °C		63	Α		
		-Continuous		T <sub>A</sub> = 25 °C	(Note 1a)	17.5	A		
		-Pulsed				70			
E <sub>AS</sub>	Single Pulse A	Single Pulse Avalanche Energy (Note 4)			54	mJ			
P <sub>D</sub>	Power Dissipat	ion		T <sub>C</sub> = 25 °C		31	W		
	Power Dissipation			T <sub>A</sub> = 25 °C	(Note 1a)	2.3	VV		
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range			-55 to +150	°C				
Thermal Ch	naracteristics								
$R_{\theta JC}$	Thermal Resistance, Junction to Case			4.0	°C/W				
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient (Note 1a)			53					
	arking and O	rdering Informa	ation						
Davias M	arling	Davias	Deeker		Deal Size	Tome Width	Quantity		

Device Marking Device		Package Reel Size		Tape Width	Quantity	
FDMC7678	FDMC7678	MLP 3.3x3.3	13 "	12 mm	3000 units	

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Symbol	Parameter	Test Conditions	Min	Тур	Max	Units	
Off Chara	octeristics						
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	$I_{D} = 250 \ \mu A, \ V_{GS} = 0 \ V$	30			V	
ΔBV <sub>DSS</sub> ΔT <sub>J</sub>	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$ , referenced to 25 °C		21		mV/°C	
DSS	Zero Gate Voltage Drain Current $V_{DS} = 24 V, V_{GS} = 0 V$				1	μΑ	
GSS	Gate to Source Leakage Current, Forward	V <sub>GS</sub> = 20 V, V <sub>DS</sub> = 0 V			100	nA	
)n Chara	cteristics						
/ <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \ \mu A$	1.2	1.5	3.0	V	
$\Delta V_{GS(th)}$ $\Delta T_{.1}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$ , referenced to 25 °C		-5		mV/°C	
r <sub>DS(on)</sub>	Static Drain to Source On Resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 17.5 A		4.2	5.3		
		$V_{GS} = 4.5 \text{ V}, I_D = 15.0 \text{ A}$		5.1	6.8		
		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 17.5 \text{ A}$ T <sub>J</sub> = 125 °C		5.7	7.2	mΩ	
Ĵfs	Forward Transconductance	V <sub>DD</sub> = 5 V, I <sub>D</sub> = 17.5 A		90		S	
ynamic	Characteristics						
viss	Input Capacitance			1810	2410	pF	
Soss	Output Capacitance	$V_{DS} = 15 V, V_{GS} = 0 V$		620	820	pF	
rss	Reverse Transfer Capacitance	f = 1MHz		75	110	pF	
۲ <sub>g</sub>	Gate Resistance			0.7	2.5	Ω	
witching	g Characteristics						
d(on)	Turn-On Delay Time			10	19	ns	
r	Rise Time	V <sub>DD</sub> = 15 V, I <sub>D</sub> = 17.5 A		4	10	ns	
d(off)	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		26	41	ns	
f	Fall Time			3	10	ns	
	Total Gate Charge	V <sub>GS</sub> = 0 V to 10 V		28	39	nC	
و <sub>(TOT)</sub>	Total Gate Charge	$V_{GS} = 0 \text{ V to } 4.5 \text{ V} \text{ V}_{DD} = 15 \text{ V}$		14	19	nC	
ک <sub>gs</sub>	Gate to Source Charge	I <sub>D</sub> = 17.5 A		4.4		nC	
λ <sup>dd</sup>	Gate to Drain "Miller" Charge	_		3.9		nC	
•	urce Diode Characteristics	·					
V <sub>SD</sub>	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_{S} = 1.9 A$ (Note 2)		0.7	1.2		
		$V_{GS} = 0 V, I_S = 17.5 A$ (Note 2)		0.8	1.2	V	
rr	Reverse Recovery Time	I = 17.5  A di/dt = 100  A/ma		30	49	ns	
2 <sub>rr</sub>	Reverse Recovery Charge	—I <sub>F</sub> = 17.5 A, di/dt = 100 A/μs		13	23	nC	



a. 53 °C/W when mounted on a 1 in<sup>2</sup> pad of 2 oz copper

3. As an N-ch device, the negative V<sub>GS</sub> rating is for low duty cycle pulse occurence only. No continuous rating is implied.

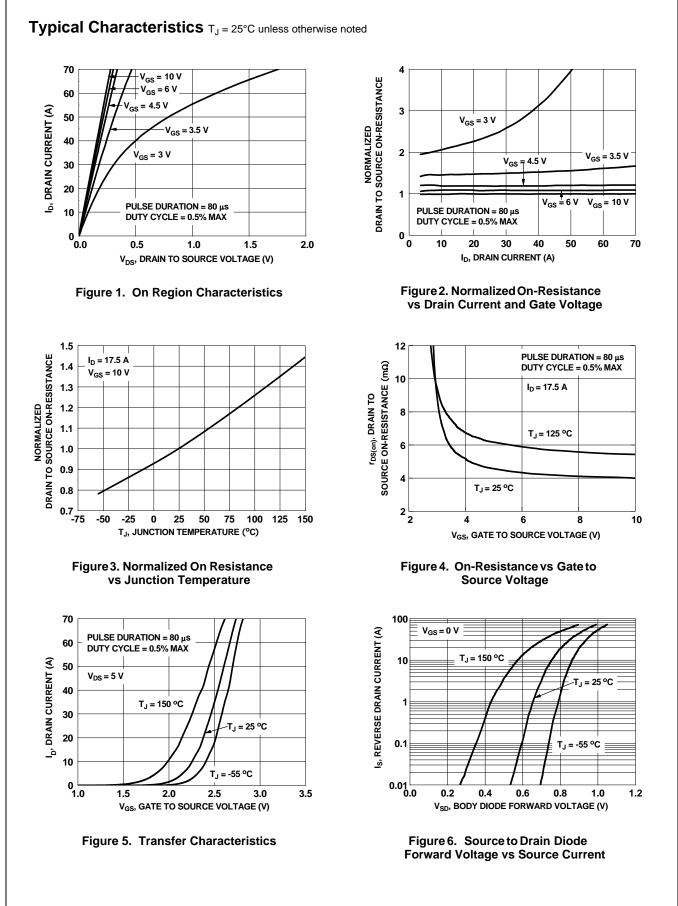
4.  $E_{AS}$  of 54 mJ is based on starting  $T_{J}$  = 25 °C, L = 0.3 mH,  $I_{AS}$  = 19 A,  $V_{DD}$  = 27 V,  $V_{GS}$  = 10 V.



b.125 °C/W when mounted on a minimum pad of 2 oz copper

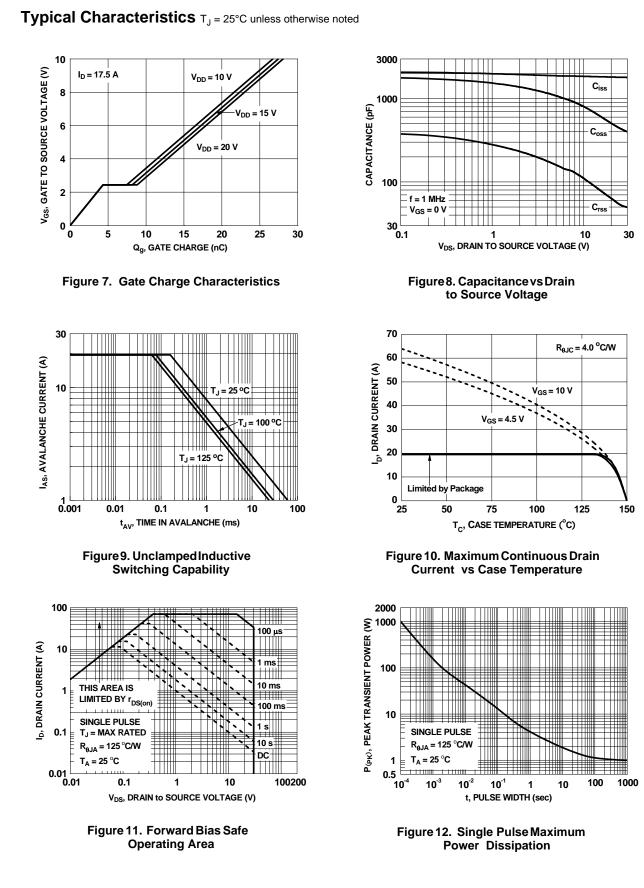
2. Pulse Test: Pulse Width < 300  $\mu s,$  Duty cycle < 2.0 %.

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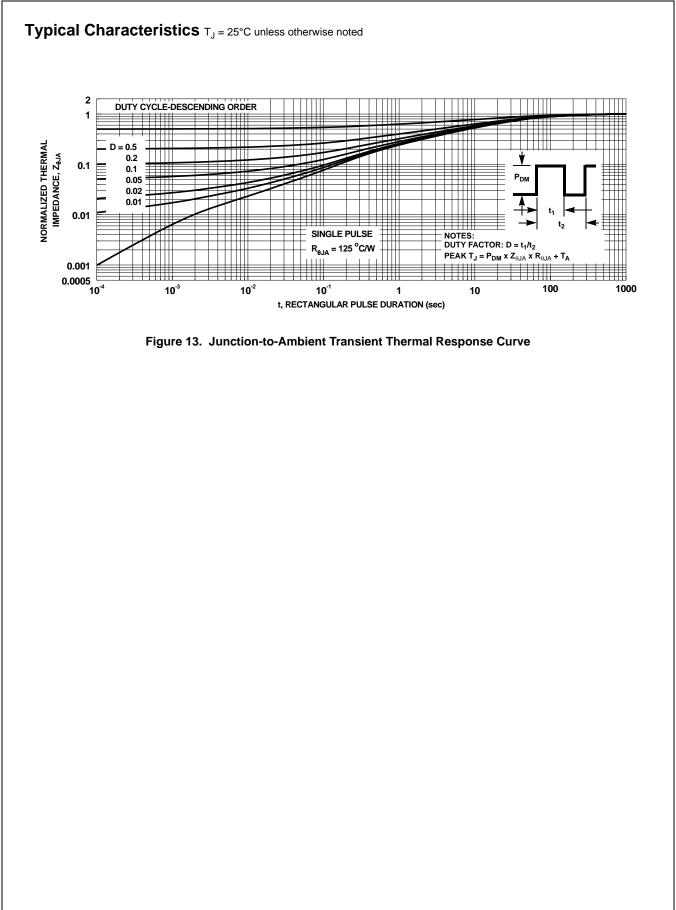


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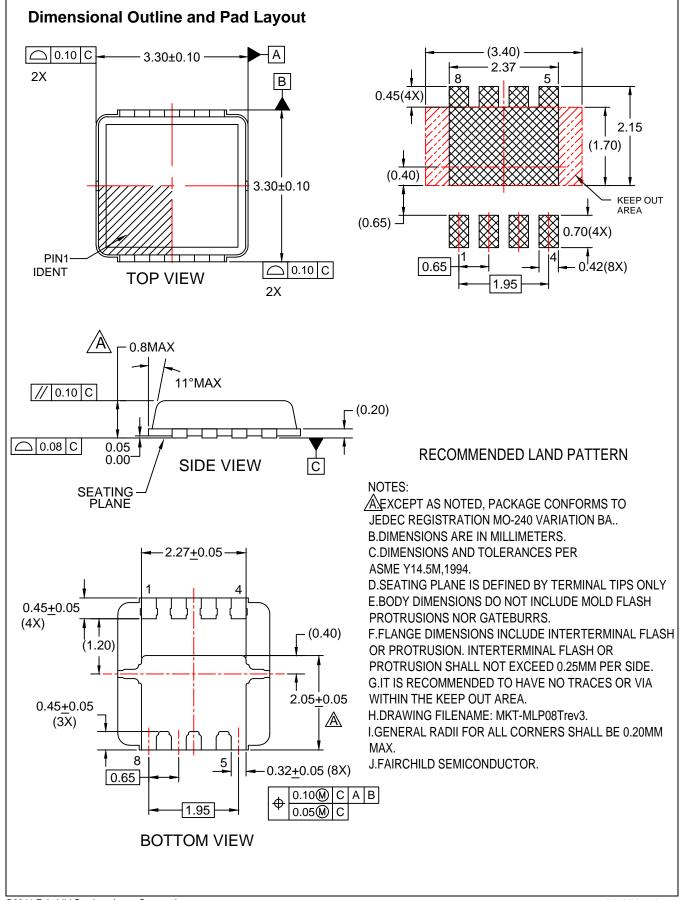




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